10/13/2021 506920447

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6967282

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT	
NATURE OF CONVEYANCE:	Corrective Assignment to correct the INADVERTENTLY OMITTED ASSIGNEE previously recorded on Reel 053834 Frame 0452. Assignor(s) hereby confirms the ASSIGNMENT.	

CONVEYING PARTY DATA

Name	Execution Date
SHIH-YEN LIN	12/19/2017
SI-CHEN LEE	12/21/2017
SAMUEL C. PAN	12/27/2017
KUAN-CHAO CHEN	12/19/2017

RECEIVING PARTY DATA

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State/Country:	TAIWAN	
Postal Code:	300	
Name:	NATIONAL TAIWAN UNIVERSITY	
Street Address:	NO. 1, SEC. 4, ROOSEVELT ROAD	
City:	TAIPEI	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17027237

CORRESPONDENCE DATA

Fax Number: (202)756-8087

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

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Address Line 4: WASHINGTON, D.C. 20001

> **PATENT REEL: 057935 FRAME: 0973**

506920447

ATTORNEY DOCKET NUMBER:	095714-1339
NAME OF SUBMITTER:	LYNN CRUZ
SIGNATURE:	/LYNN CRUZ/
DATE SIGNED:	10/13/2021

Total Attachments: 4

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> PATENT REEL: 057935 FRAME: 0974

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHIH-YEN LIN	12/19/2017
SI-CHEN LEE	12/21/2017
SAMUEL C. PAN	12/27/2017
KUAN-CHAO CHEN	12/19/2017

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.	
Street Address:	NO.8, LI-HSIN RD. 6, SCIENCE BASED INDUSTRIAL PARK	
City:	HSINCHU	
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17027237

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	095714-1339
NAME OF SUBMITTER:	LYNN CRUZ
SIGNATURE:	/Lynn Cruz/
DATE SIGNED:	09/21/2020

Total Attachments: 3

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PATENT REEL: 057935 FRAME: 0975

EPAS ID: PAT6309387

MP-7/0/8-0-05-134 Attorney Docket No. 095714-0298 (P20161906US00)

COMBINED DECLARATION AND ASSIGNMENT FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

I believe I am the original or an original joint inventor of a claimed invention in the application for which a patent is sought on the invention entitled:

2D CRYSTAL HETERO-STRUCTURES AND MANUFACTURING METHODS THEREOF

رة ولايك	RIDING AND DIRECT CIEMPINIA PRINTED AND A CONTROL OF THE CONTROL O	
which	application is:	
\boxtimes	attached, or	
	United States application number or PCT international application number filed on	
The al	pove-identified application was made or authorized to be made by me.	
time I author associ	event that the filing date and/or application number are not entered above at the execute this document, and if such information is deemed necessary, I hereby rize and request the registered practitioners of McDermott Will & Emery LLP, ated with the Customer Number 20277, to insert above the filing date and/or ation number of the application.	
hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.		

PATENT CALL REEL: 057935 FRAME: 0976

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
No. 8, Li-Hsin Rd. 6, Science Based Industrial Park, Hsinchu, Taiwan 300

NATIONAL TAIWAN UNIVERSITY
No. 1. Sec. 4, Roosevelt Road, Taipei, Taiwan

(hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in this document.

I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights:

I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

Page 2 of 3

PATENT REEL: 057935 FRAME: 0977 I hereby covenant that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment.

Legal name of inventor	
Shih-Yen Lin	
Inventor's signature	Date 2017, 12, 19,
Legal name of inventor	
Kuan-Chao Chen	
Invariante aignotive	Date
陳廷廷	2017, 12, 19.
Legal name of inventor	
Si-Chen Lee	
Inventor's signature	Date
Sechen Lee	2017,12.3/
Legal name of inventor	***************************************
Samuel C. Pan	
Inventor's signature	Date
53/1/2	12/27/2017

g: . r